

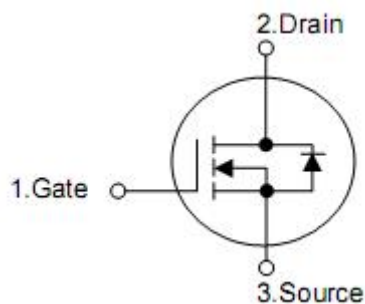
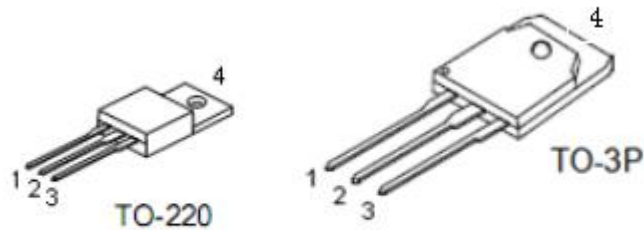
## 1. Applications

- n High efficiency synchronous rectification in SMPS
- n High speed power switching

## 2. Features

- n  $R_{DS(on)}=7.0m\Omega$  @ $V_{GS}= 10 V$
- n Super high dense cell design
- n Ultra low On-Resistance
- n 100% avalanche tested
- n Lead Free and Green devices available (RoHS Compliant)

## 3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

#### 4. Absolute maximum ratings

( $T_C=25\text{ }^\circ\text{C}$  , unless otherwise specified)

Parameter	Symbol	Ratings	Units	
Drain-source voltage	$V_{DSS}$	100	V	
Gate-source voltage	$V_{GSS}$	$\pm 25$	V	
Continuous drain current $T_C=25\text{ }^\circ\text{C}^2$	$I_D$	130	A	
Continuous drain current $T_C=100\text{ }^\circ\text{C}^2$		99	A	
300us pulsed drain current tested $T_C=25\text{ }^\circ\text{C}^1$	$I_{DP}$	560	A	
Avalanche energy single pulse <sup>3</sup>	$E_{AS}$	552	mJ	
Power dissipation	$P_D$	$T_C=25\text{ }^\circ\text{C}$	300	W
		$T_C=100\text{ }^\circ\text{C}$	150	W
Maximum junction temperature	$T_J$	175	$^\circ\text{C}$	
Storage temperature range	$T_{STG}$	-55~+175	$^\circ\text{C}$	
Diode continuous forward current $T_C=25\text{ }^\circ\text{C}$	$I_S$	140	A	

#### 5. Thermal characteristics

Parameter	Symbol	Rating	Unit
Thermal resistance,Junction-to-case	$\theta_{JC}$	0.5	$^\circ\text{C}/\text{W}$
Thermal resistance,Junction-to-ambient	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$

## 6. Electrical characteristics

(T<sub>C</sub>=25°C, unless otherwise notes)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	100	-	-	V
Drain-to-source leakage current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	-	-	1	μA
		T <sub>J</sub> =125 °C	-	-	30	μA
Gate-to-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =25V, V <sub>DS</sub> =0V	-	-	100	nA
		V <sub>GS</sub> =-25V, V <sub>DS</sub> =0V	-	-	-100	nA
<b>On characteristics</b>						
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	-	4.0	V
Static drain-source on-resistance <sup>4</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =70A	-	7.0	9.0	mΩ
<b>Gate charge characteristics<sup>5</sup></b>						
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> =80V, I <sub>D</sub> =70A, V <sub>GS</sub> =10V	-	130	-	nC
Gate-source charge	Q <sub>gs</sub>		-	32	-	
Gate-drain (Miller)charge	Q <sub>gd</sub>		-	55	-	
<b>Dynamic characteristics<sup>5</sup></b>						
Gate series resistance	R <sub>G</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1.0MHz	-	1	-	Ω
Turn-on delay time	T <sub>d(ON)</sub>	V <sub>DD</sub> =50V, I <sub>D</sub> =70A, V <sub>GEN</sub> =10V, R <sub>G</sub> =5Ω	-	24	-	nS
Rise time	t <sub>rise</sub>		-	91	-	
Turn-off delay time	T <sub>d(OFF)</sub>		-	75	-	
Fall time	t <sub>fall</sub>		-	65	-	
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f=1.0MHz	-	6800	-	pF
Output capacitance	C <sub>oss</sub>		-	630	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	350	-	
<b>Source-drain body diode characteristics T<sub>J</sub>=25°C, unless otherwise notes</b>						
Diode forward voltage <sup>4</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =70A	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	I <sub>SD</sub> =70A, di <sub>F</sub> /dt=100A/μs,	-	43	-	ns
Reverse recovery charge	Q <sub>rr</sub>		-	67	-	nC

Note: 1. Pulse width limited by safe operating area.

2. Calculated continuous current based on maximum allowable junction temperature. The package limitation current is 75A

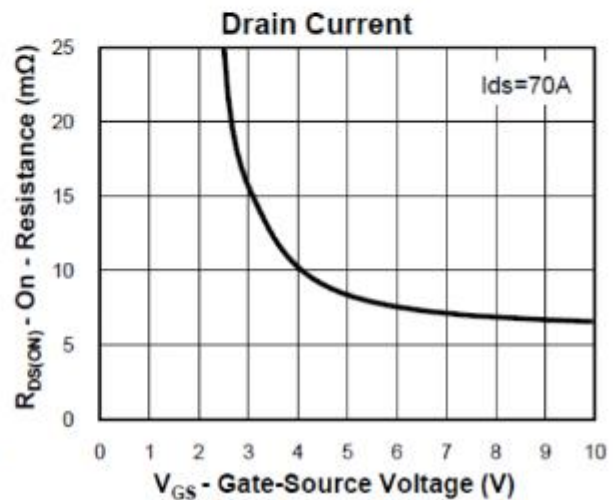
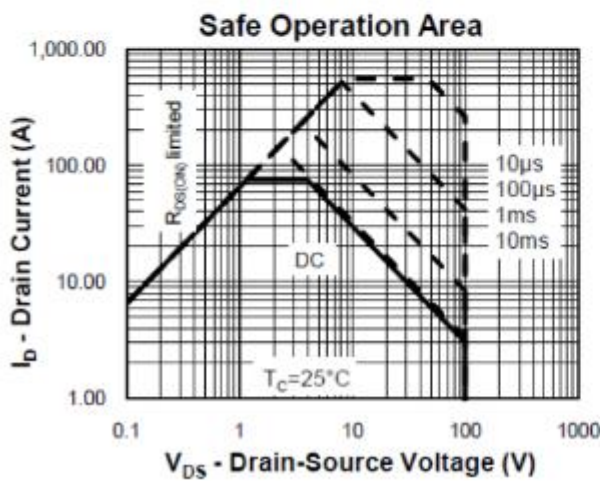
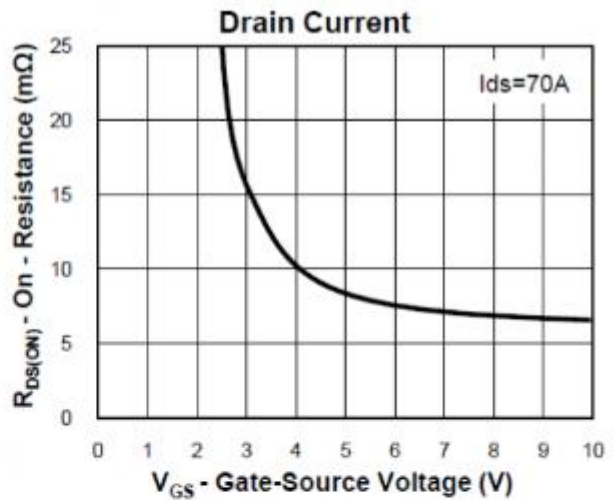
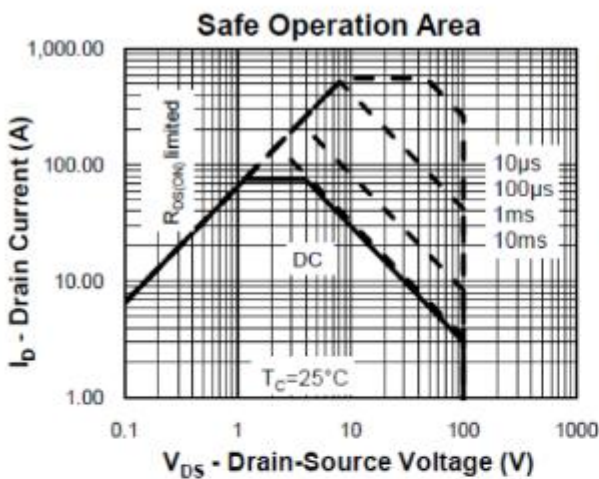
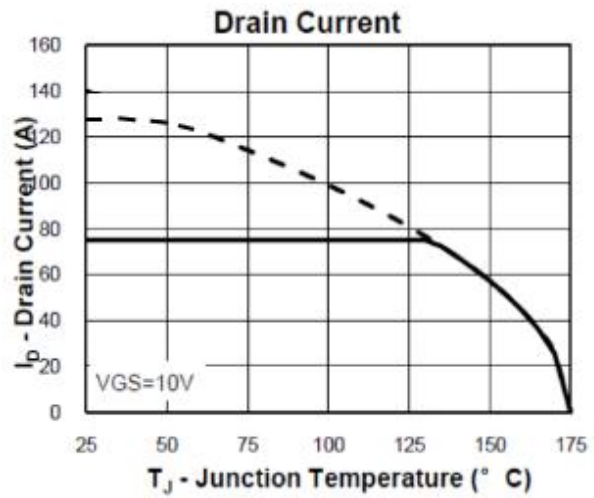
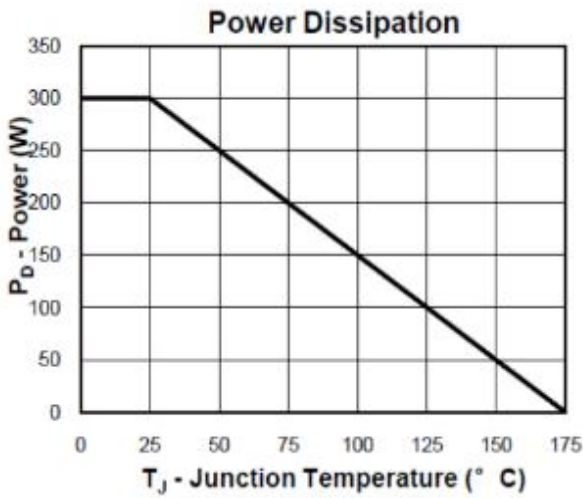
3. Limited by T<sub>Jmax</sub>, I<sub>AS</sub>=47A, V<sub>DD</sub>=48V, R<sub>G</sub>=50Ω, Starting T<sub>J</sub>=25°C.

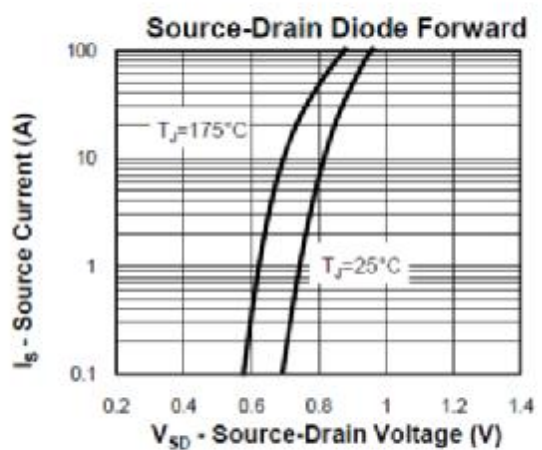
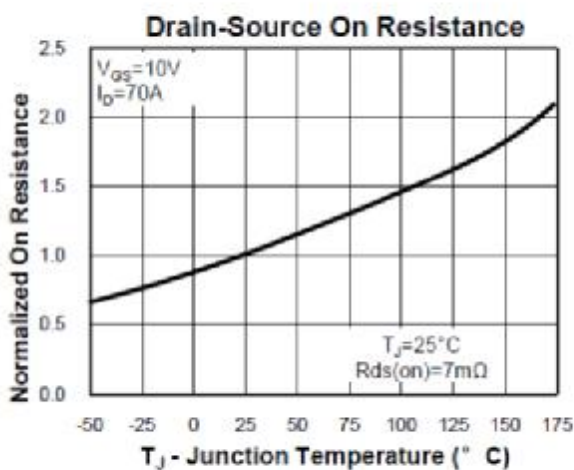
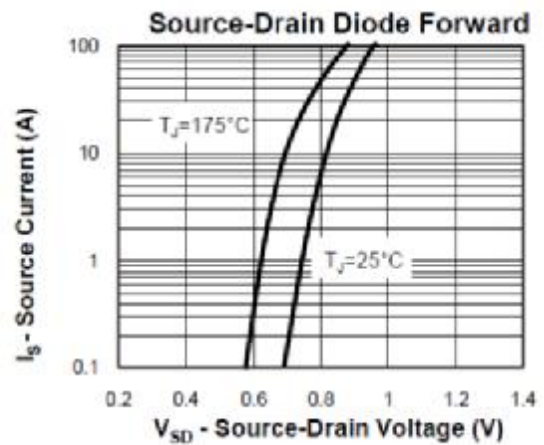
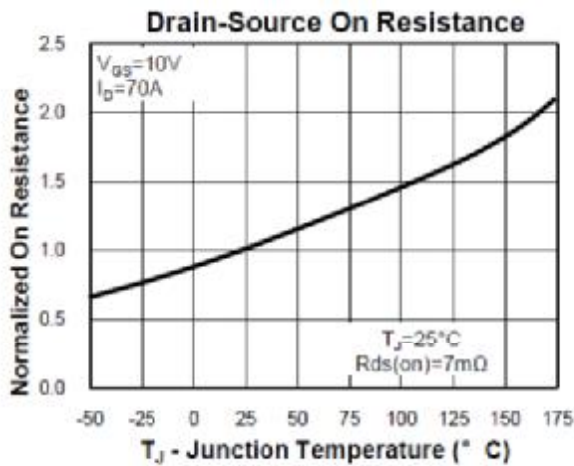
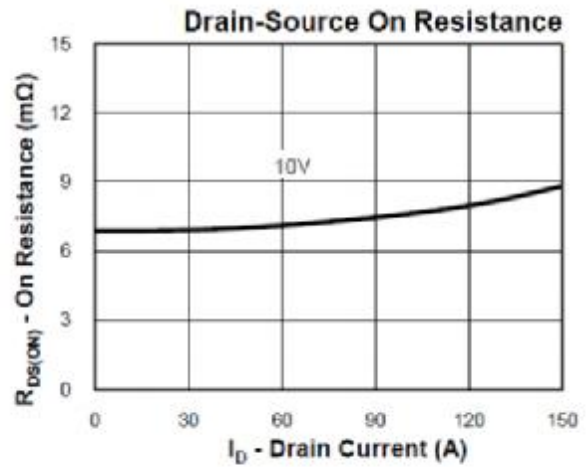
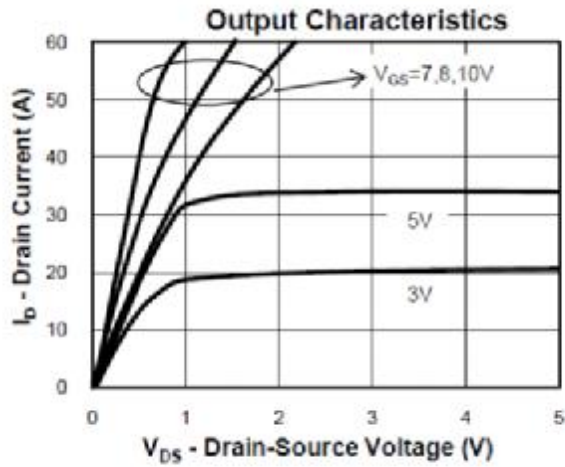
4. Pulse test; Pulse width ≤300μs; duty cycle ≤2%.

5. Guaranteed by design, not subject to production testing.

6. KIA finished product specifications please customer before placing order, should obtain the latest version of the finished product specifications.

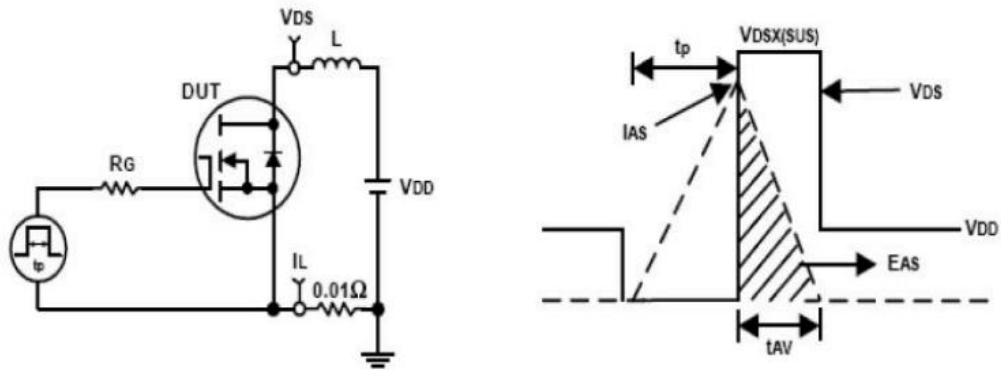
7. Typical characteristics





8. Test circuits and waveforms

**Avalanche Test Circuit and Waveforms**



**Switching Time Test Circuit and Waveforms**

